

January 7, 1998

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### AXIAL LEADED HERMETICALLY SEALED FAST RECOVERY RECTIFIER DIODE

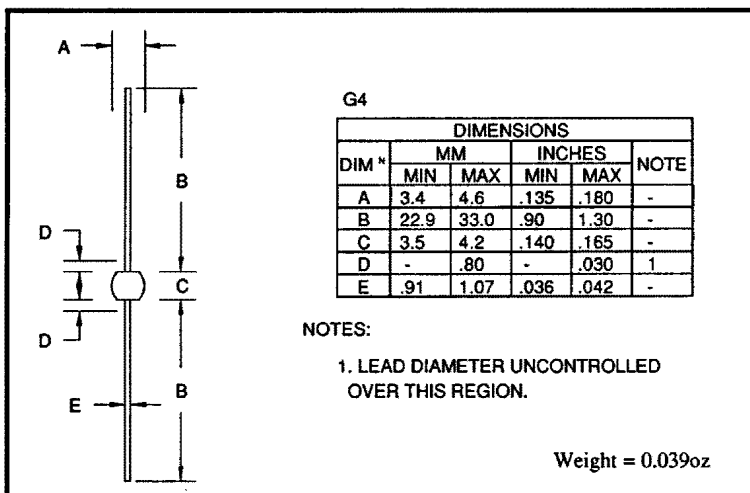
### QUICK REFERENCE DATA

- Low reverse recovery time
  - Hermetically sealed in Metoxilite fused metal oxide
  - Low switching losses
  - High thermal shock resistance
  - Soft, non-snap off, recovery characteristics
- $V_R = 1000V$
  - $I_F = 3.25A$
  - $t_{rr} = 150nS$
  - $I_R = 1\mu A$

### ABSOLUTE MAXIMUM RATINGS (@ 25°C unless otherwise specified)

	Symbol	3SFR0	Unit
Working reverse voltage	$V_{RWM}$	1000	V
Repetitive reverse voltage	$V_{RRM}$	1000	V
Average forward current (@ 55°C, lead length 0.375")	$I_{F(AV)}$	3.25	A
Repetitive surge current (@ 55°C in free air, lead length 0.375")	$I_{FRM}$	15.0	A
Non-repetitive surge current ( $t_p = 8.3mS$ , @ $V_R$ & $T_{jmax}$ )	$I_{FSM}$	80.0	A
Storage temperature range	$T_{STG}$	-65 to +175	°C
Operating temperature range	$T_{OP}$	-65 to +175	°C

### MECHANICAL



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**ELECTRICAL CHARACTERISTICS** (@ 25°C unless otherwise specified)

	Symbol	3SFR0	Unit
Average forward current max. (pcb mounted; $T_A = 55^\circ\text{C}$ ) for sine wave	$I_{F(AV)}$	1.2	A
	$I_{F(AV)}$	1.3	A
Average forward current max. ( $T_L = 55^\circ\text{C}$ ; $L = 3/8''$ ) for sine wave	$I_{F(AV)}$	3.00	A
	$I_{F(AV)}$	3.25	A
$I^2t$ for fusing ( $t = 8.3\text{mS}$ ) max.	$I^2t$	26	$\text{A}^2\text{S}$
Forward voltage drop max. @ $I_F = 3.0\text{A}$ , $T_j = 25^\circ\text{C}$	$V_F$	1.5	V
Reverse current max. @ $V_{RWM}$ , $T_j = 25^\circ\text{C}$	$I_R$	1.0	$\mu\text{A}$
	$I_R$	25	$\mu\text{A}$
Reverse recovery time max. 0.5A $I_F$ to 1.0A $I_R$ . Recovers to 0.25A $I_{RR}$ .	$t_{rr}$	150	nS
Junction capacitance typ. @ $V_R = 5\text{V}$ , $f = 1\text{MHz}$	$C_j$	80	$\rho\text{F}$

**THERMAL CHARACTERISTICS**

	Symbol	3SFR0	Unit
Thermal resistance - junction to lead Lead length = 0"	$R_{\theta JL}$	4	$^\circ\text{C}/\text{W}$
	$R_{\theta JL}$	20	$^\circ\text{C}/\text{W}$
Thermal resistance - junction to amb. on 0.06" thick pcb. 1 oz. copper.	$R_{\theta JA}$	75	$^\circ\text{C}/\text{W}$

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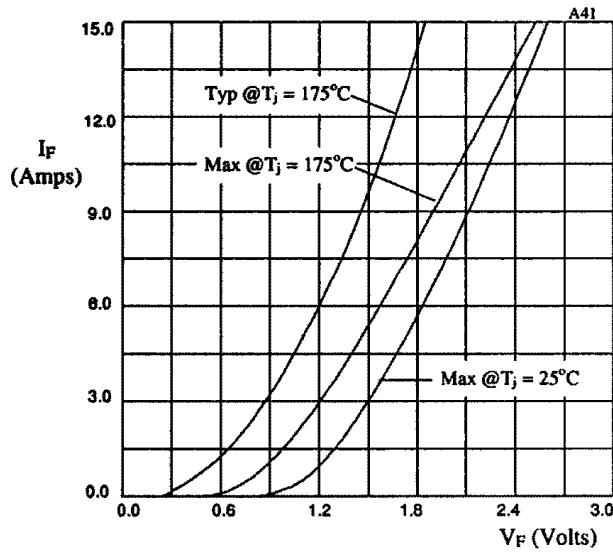


Fig 1. Forward voltage drop as a function of forward current.

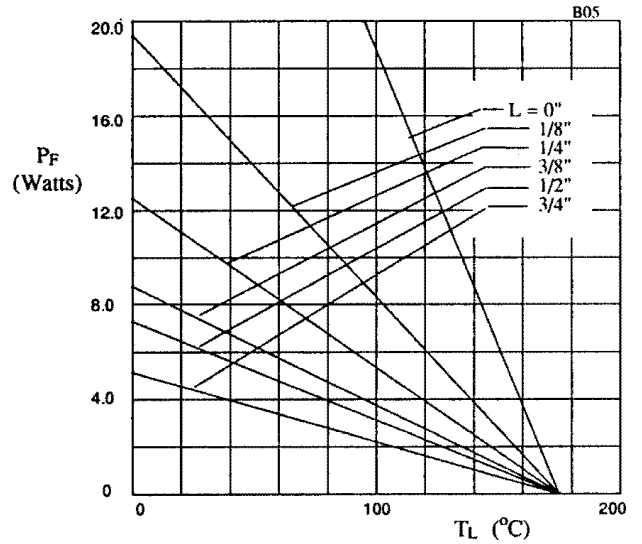


Fig 2. Maximum power versus lead temperature.

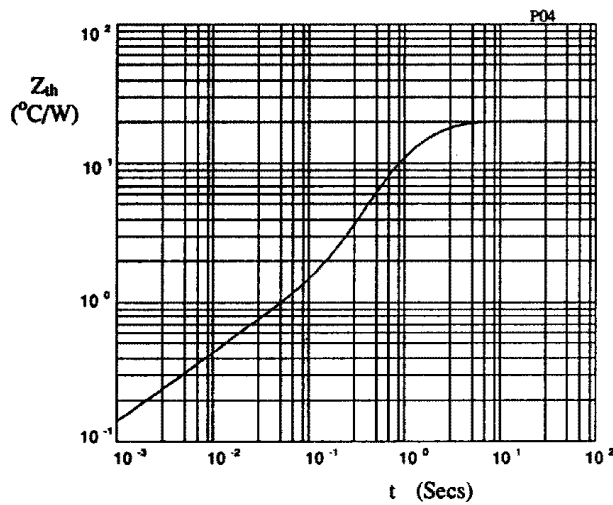


Fig 3. Transient thermal impedance characteristic.

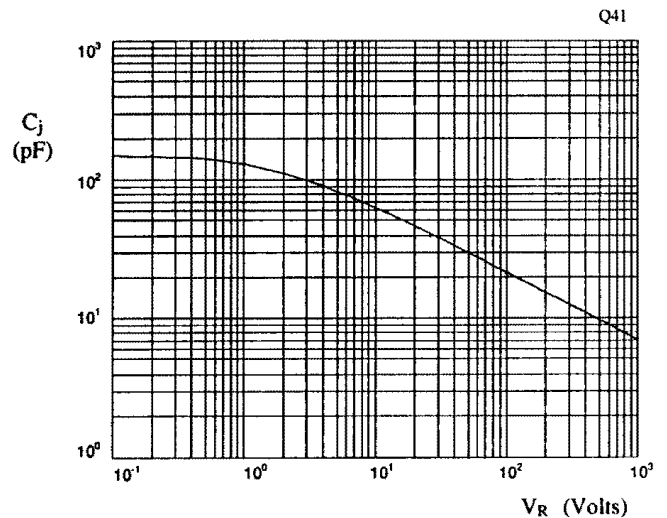


Fig 4. Typical junction capacitance as a function of reverse voltage.

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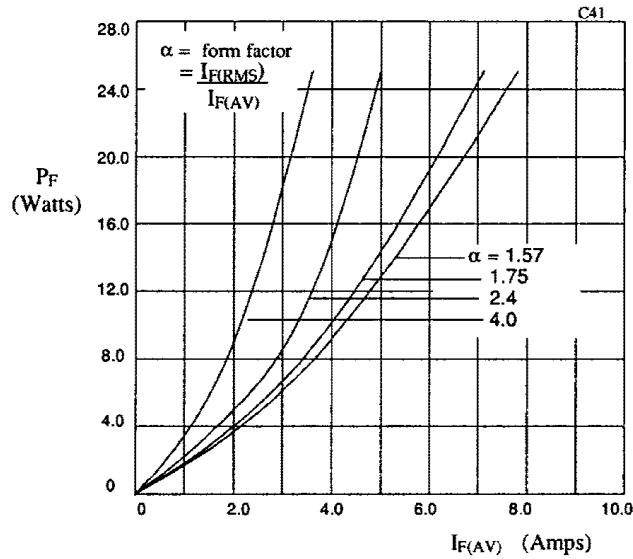


Fig 5. Forward power dissipation as a function of forward current, for sinusoidal operation.

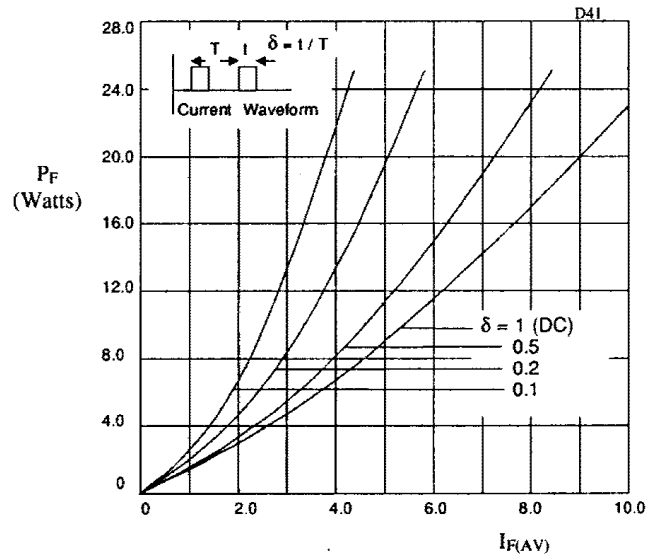


Fig 6. Forward power dissipation as a function of forward current, for square wave operation.

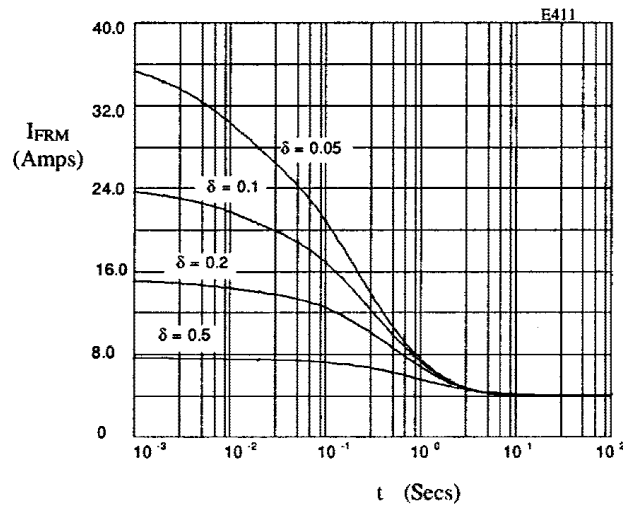


Fig 7. Typical repetitive forward current as a function of pulse width at 55°C;  $R_{\theta JL} = 20\text{ }^{\circ}\text{C/W}$ ;  $V_{RWM}$  during  $1 - \delta$ .

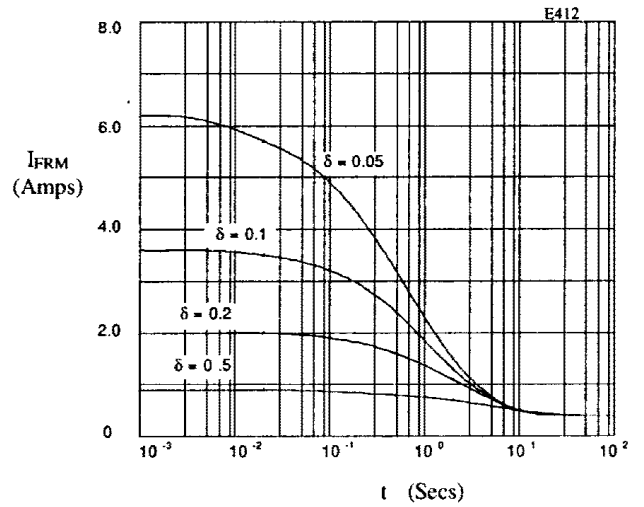


Fig 8. Typical repetitive forward current as a function of pulse width at 100°C;  $R_{\theta JL} = 80\text{ }^{\circ}\text{C/W}$ ;  $V_{RWM}$  during  $1 - \delta$ .